

### Lamp

## 7383/BAC3-ANQA/X/MS



### Features

- Popular T-1 3/4 round package.
- Choice of various viewing angles.
- Available on tape and reel.
- Reliable and robust.
- The product itself will remain within RoHS compliant version.

### Descriptions

- The series is specially designed for applications requiring higher brightness.
- The LED lamps are available with different colors, intensities, epoxy colors, etc.

### Applications

- Color Graphic Signs
- Message boards
- Variable message signs (VMS)
- Commercial outdoor advertising

**Device Selection Guide**

LED Part No.	Chip Materials	Emitted Color	Resin Color	Stopper
7383/B1C3-ANQA/MS	InGaN	Blue	Water Clear	No
7383/B1C3-ANQA/P/MS				Yes

**Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	$V_R$	5	V
Forward Current	$I_F$	30	mA
Peak Forward Current (Duty 1/10 @1KHz)	$I_{FP}$	100	mA
Power Dissipation	$P_d$	120	mW
Operating Temperature	$T_{opr}$	-40 ~ +85	°C
Storage Temperature	$T_{stg}$	-40 ~ +100	°C
ESD	$ESD_{HBM}$	1K	V
Soldering Temperature	$T_{sol}$	260 °C for 5 sec.	

**Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Radiometric Intensity	$I_v$	2250	2850	4500	mcd	$I_F=20mA$
Viewing Angle	$2\theta_{1/2}$	--	30	--	deg	$I_F=20mA$
Peak Wavelength	$\lambda_p$	--	468	--	nm	$I_F=20mA$
Dominant Wavelength	$\lambda_d$	465	470	475	nm	$I_F=20mA$
Spectrum Radiation Bandwidth	$\Delta\lambda$	--	26	--	nm	$I_F=20mA$
Forward Voltage	$V_F$	2.8	--	3.6	V	$I_F=20mA$
Reverse Current	$I_R$	--	--	50	$\mu A$	$V_R=5V$

**Bin Range of Radiometric Intensity**

Bin Code	Min.	Max.	Unit	Condition
N	2250	2850	mcd	I <sub>F</sub> =20mA
P	2850	3600		
Q	3600	4500		

Note:  
Measurement Uncertainty of Radiometric Intensity: ±10%

**Bin Range of Dominant Wavelength**

Bin Code	Min.	Max.	Unit	Condition
1	465	470	nm	I <sub>F</sub> =20mA
2	470	475		

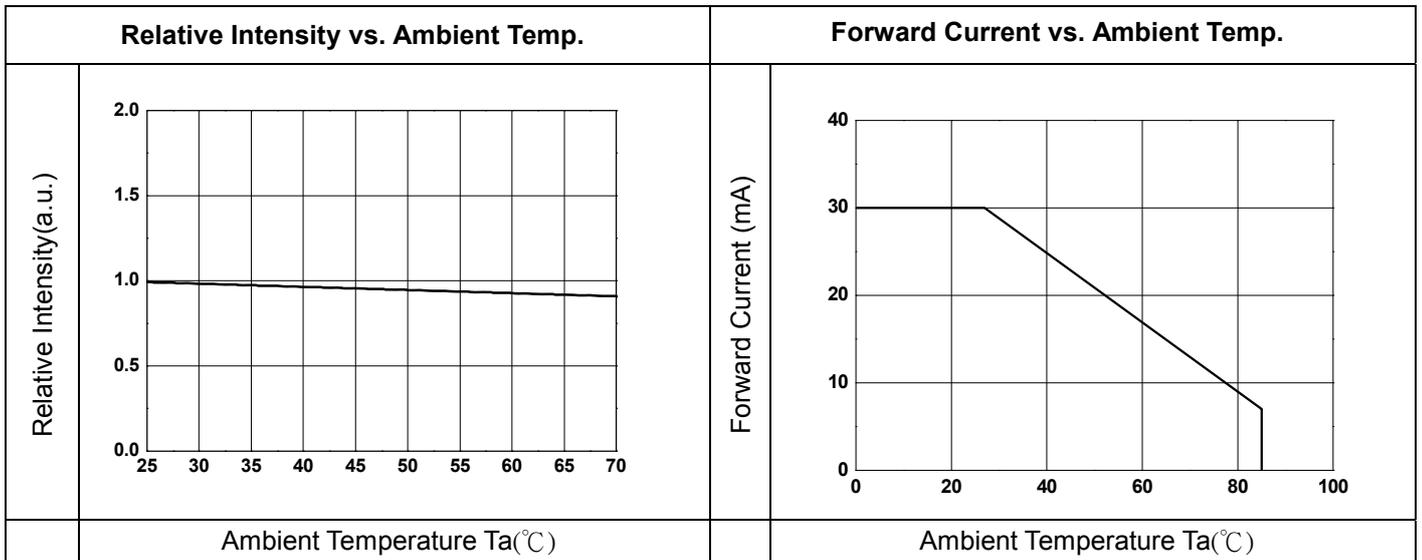
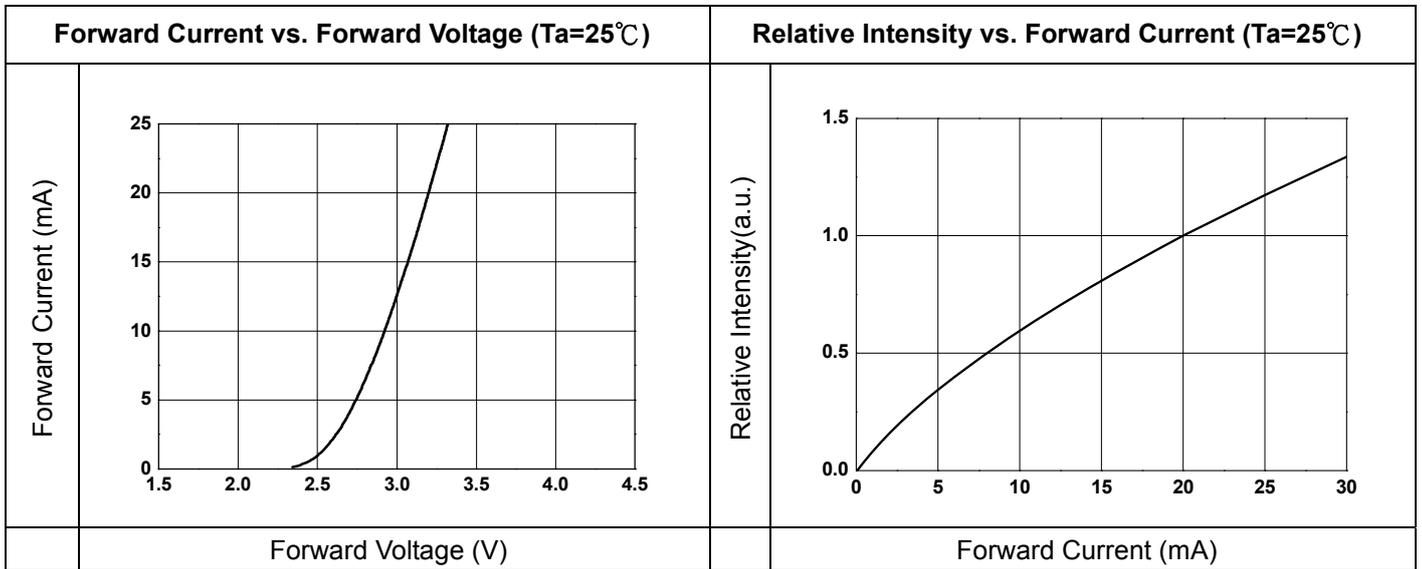
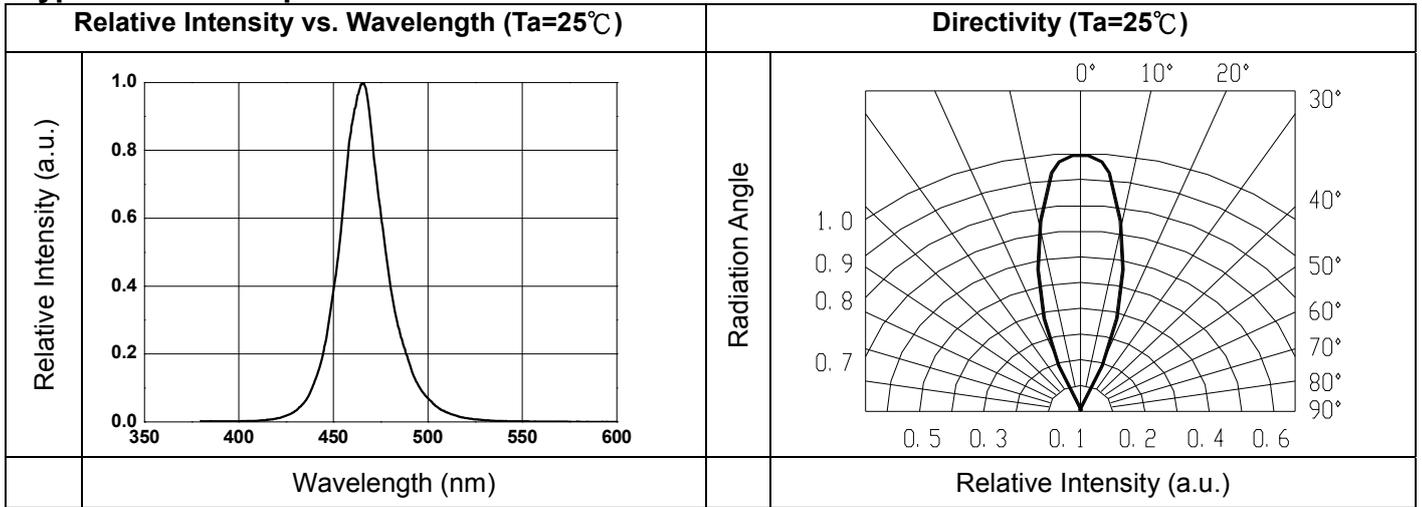
Note:  
Measurement Uncertainty of Dominant Wavelength ±1.0nm

**Bin Range of Forward Voltage**

Bin Code	Min.	Max.	Unit	Condition
0	2.8	3.0	V	I <sub>F</sub> =20mA
1	3.0	3.2		
2	3.2	3.4		
3	3.4	3.6		

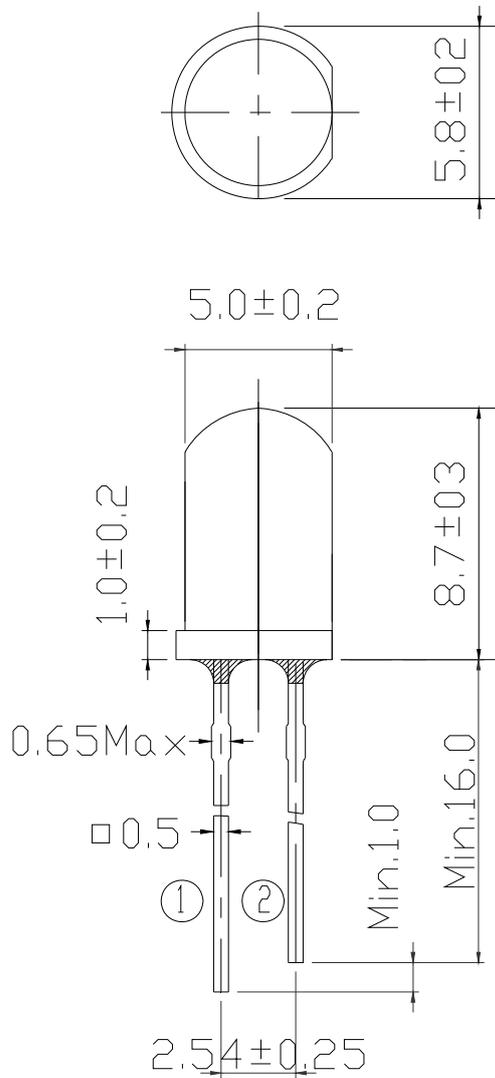
Note:  
Tolerance of Forward Voltage: ±0.1V

**Typical Electro-Optical Characteristics Curves**

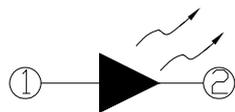
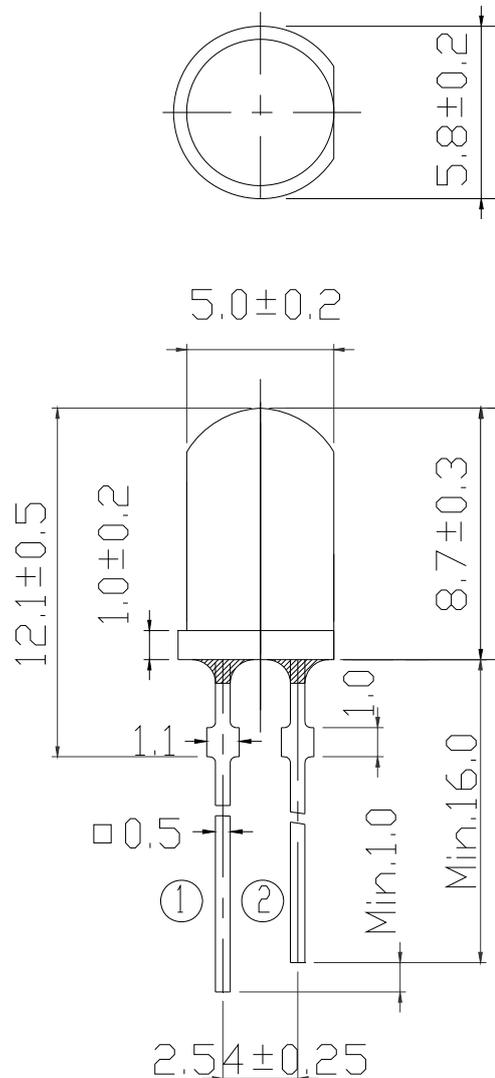


Package Dimension

No Stopper Type



Stopper Type



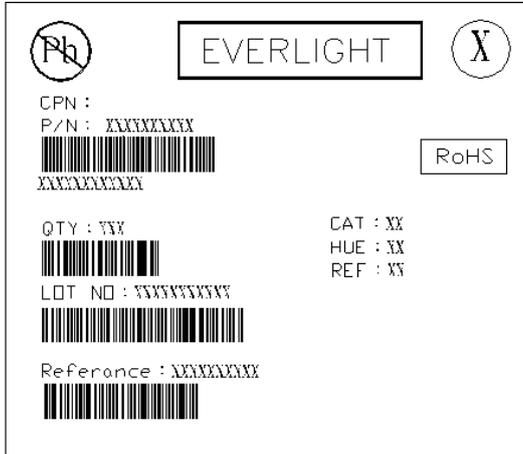
① Anode  
② Cathode

Note:

- \* Other dimensions are in millimeters, tolerance is 0.25mm except being specified.
- \* Protruded resin under flange is 1.5mm Max LED.

## Moisture Resistant Packing Materials

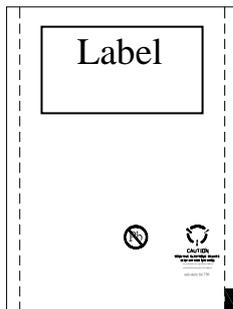
### Label Explanation



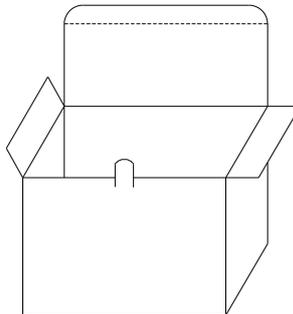
- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Ranks of Luminous Intensity and Forward Voltage
- HUE: Rank of Dominant Wavelength
- REF: Reference
- LOT No: Lot Number

### Packing Specification

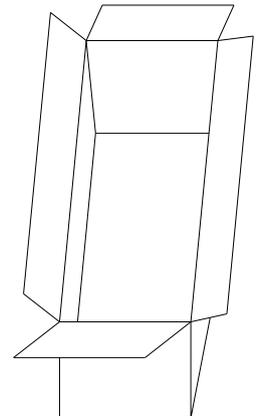
#### ■ Anti-electrostatic bag



#### ■ Inner Carton



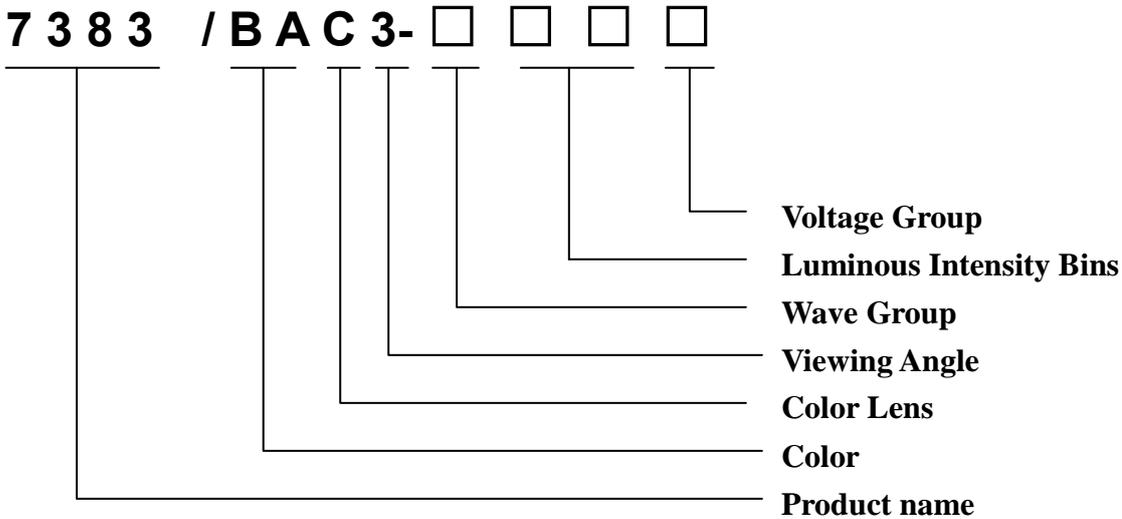
#### ■ Outside Carton



#### ■ Packing Quantity

1. Min 200pcs to Max 500 PCS/1 Bag, 5 Bags/1 Inner Carton.
2. 10 Inner Cartons/1 Outside Carton

## Production Designation



## Notes

### 1. Lead Forming

- During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
- Lead forming should be done before soldering.
- Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.
- When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

### 2. Storage

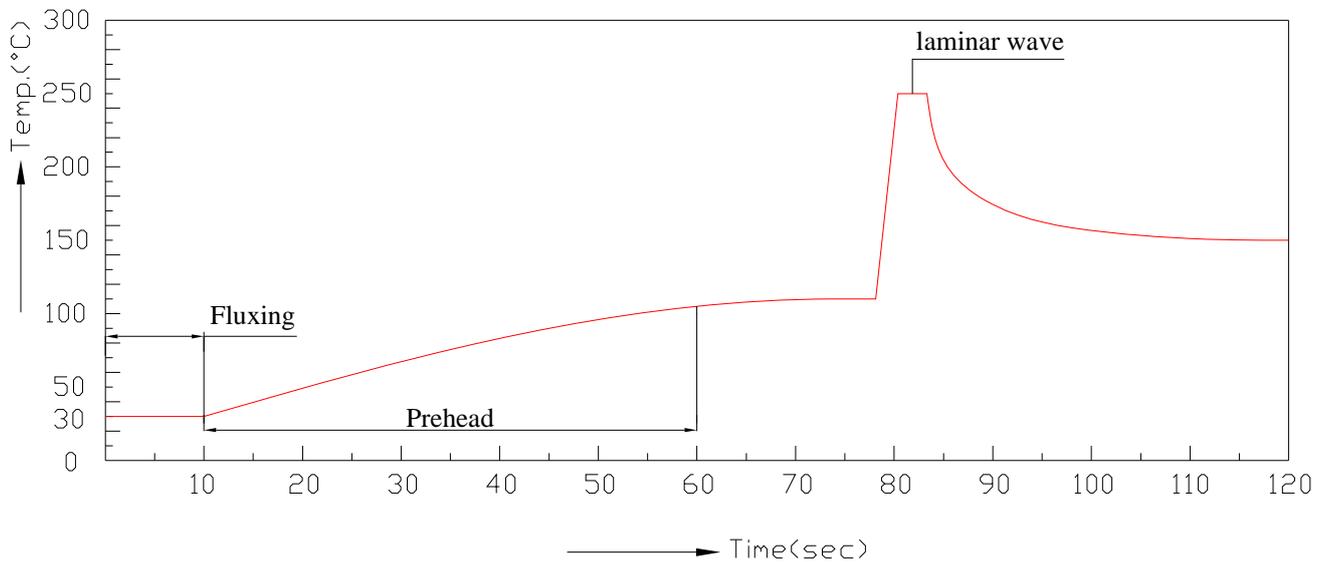
- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Everlight and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

3. Soldering

- Careful attention should be paid during soldering. When soldering, leave more than 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.
- Recommended soldering conditions:

Hand Soldering		DIP Soldering	
Temp. at tip of iron	300°C Max. (30W Max.)	Preheat temp.	100°C Max. (60 sec Max.)
Soldering time	3 sec Max.	Bath temp. & time	260 Max., 5 sec Max
Distance	3mm Min.(From solder joint to epoxy bulb)	Distance	3mm Min. (From solder joint to epoxy bulb)

- Recommended soldering profile



- Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.
- Dip and hand soldering should not be done more than one time
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Although the recommended soldering conditions are specified in the above table, dip or handsoldering at the lowest possible temperature is desirable for the LEDs.
- Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.

4. Cleaning

- When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED

5. Heat Management

- Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.
- The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.

6. ESD (Electrostatic Discharge)

- Electrostatic discharge (ESD) or surge current (EOS) can damage LEDs.
- An ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling LEDs.
- All devices, equipment and machinery must be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing.

7. Other

- Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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